

60V N-Channel Enhancement Mode MOSFET

Voltage 60 V Current

4.0 A

Features

- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@3.0A<100m\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_{D}@2.0A<110m\Omega$
- Advanced Trench Process Technology
- High density cell design for ultra low on-resistance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

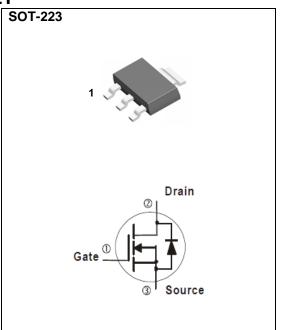
Mechanical Data

• Case: SOT-223 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.043 ounces, 0.123 grams

Marking: W4N06A



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	<u>+</u> 20	V	
Continuous Drain Current	T _A =25°C		4	А	
	T _A =70°C	l _D	3.2		
Pulsed Drain Current (Note 1)		I _{DM}	8	А	
Power Dissipation	T _A =25°C	P _D	3.1	W	
	T _A =70°C		2		
Operating Junction and Storage Temperature Range		T_{J}, T_{STG}	-55~150	°C	
Typical Thermal resistance - Junction to Ambient (Note 5)		Rеja	40.3	°C/W	

• Limited only By Maximum Junction Temperature



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250uA	60	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250uA	1.0	1.86	2.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V,I _D =3.0A	-	85	100	100 110 mΩ	
		V _{GS} =4.5V,I _D =2.0A	-	95	110		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =48V,V _{GS} =0V	-	-	1.0	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V,V _{DS} =0V	-	-	<u>+</u> 100	nA	
Dynamic (Note 6)							
Total Gate Charge	Qg		-	5.1	-	nC	
Gate-Source Charge	Qgs	V _{DS} =48V, I _D =3A,	-	1.2	-		
Gate-Drain Charge	Qgd	V _{GS} =4.5V (Note 2,3)	-	1.9	-		
Input Capacitance	Ciss	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-	509	-	pF	
Output Capacitance	Coss	V _{DS} =15V, V _{GS} =0V,	-	39	-		
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	26	-		
Turn-On Delay Time	td(on)	N/ 00\/ 1 0A	-	1.6	-		
Turn-On Rise Time	tr	V _{DD} =30V, I _D =3A,	-	7.3	-	ns	
Turn-Off Delay Time	td(off)	V _{GS} =10V, R _G =3.3Ω (Note 2,3)	-	25	-		
Turn-Off Fall Time	tf	RG=3.312 (Note 2,3)	-	14	-		
Drain-Source Diode							
Maximum Continuous Drain-Source	1		-	-	4	А	
Diode Forward Current	I _S						
Diode Forward Voltage	V _{SD}	I _S =1A,V _{GS} =0V	-	0.8	1.2	V	

NOTES:

- 1. Pulse width<300us, Duty cycle<2%
- 2. Essentially independent of operating temperature typical characteristics
- 3. Repetitive rating, pulse width limited by junction temperature TJ(MAX)=150°C. Ratings are based on low frequency and duty cycles to keep initial TJ =25°C.
- 4. The maximum current rating is package limited
- 5. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing



TYPICAL CHARACTERISTIC CURVES

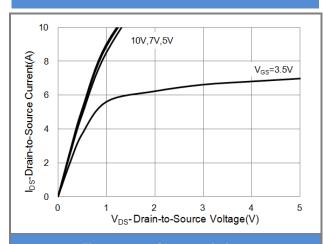


Fig.1 Output Characteristics

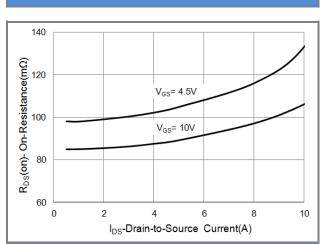


Fig.3 On-Resistance vs. Drain Current

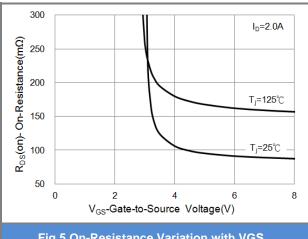


Fig.5 On-Resistance Variation with VGS.

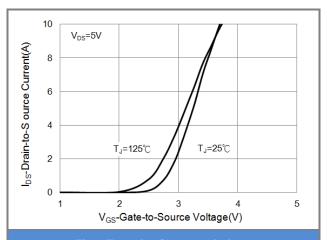


Fig.2 Transfer Characteristics

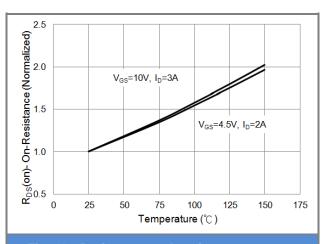


Fig.4 On-Resistance vs. Junction temperature

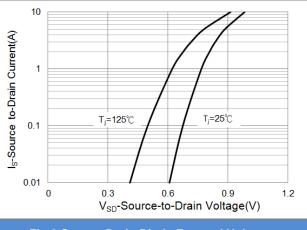


Fig.6 Source-Drain Diode Forward Voltage



TYPICAL CHARACTERISTIC CURVES

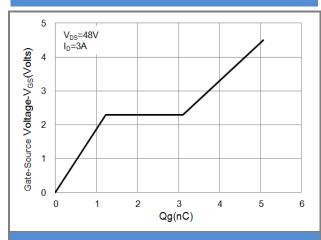
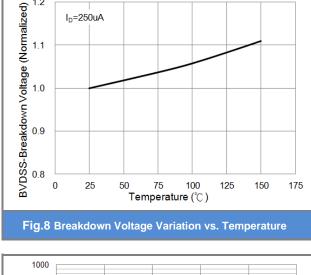


Fig.7 Gate-Charge Characteristics



I_D=250uA

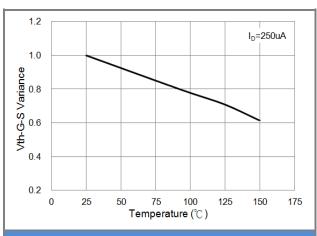


Fig.9 Threshold Voltage Variation with Temperature

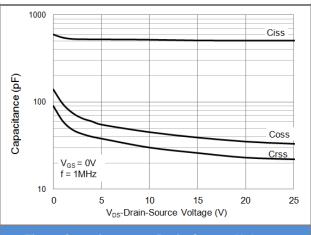


Fig.10 Capacitance vs. Drain-Source Voltage

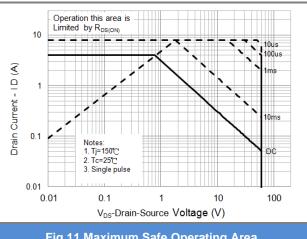


Fig.11 Maximum Safe Operating Area



TYPICAL CHARACTERISTIC CURVES

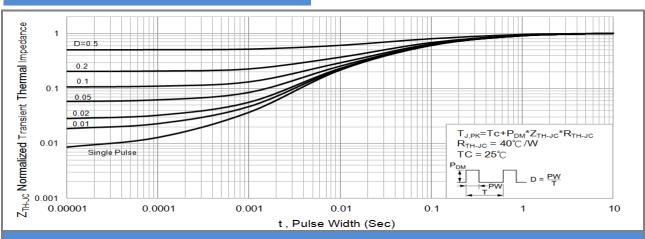
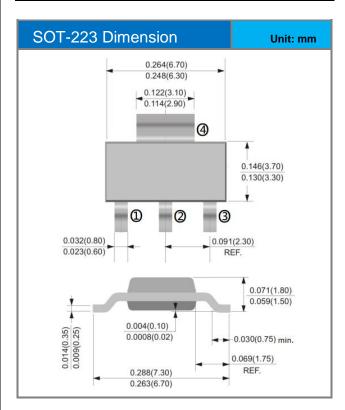


Fig.12 Normalized Transient Thermal Impedance vs. Pulse Width



Packaging Information

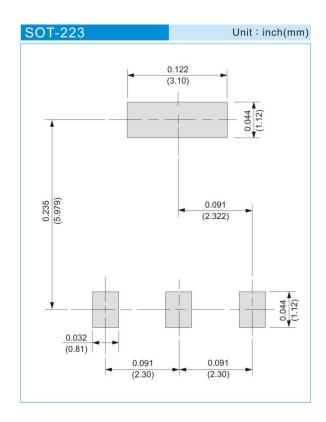




Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJW4N06A	SOT-223	2,500pcs / 13" reel	W4N06A	

Mounting Pad Layout





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